

## N&P-Channel V Complementary MOSFET

### Description

The HM609K uses advanced trench technology and design to provide excellent  $R_{DS(ON)}$  with low gate charge. It can be used in a wide variety of applications.

### General Features

#### N channel

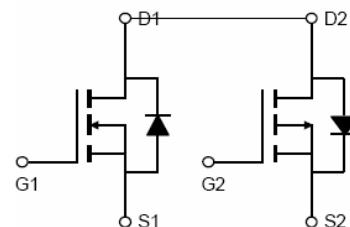
- $V_{DS} = 40V, I_D = 30A$
- $R_{DS(ON)} < 16m\Omega @ V_{GS} = 10V$
- $R_{DS(ON)} < 24m\Omega @ V_{GS} = 4.5V$

#### p channel

- $V_{DS} = -40V, I_D = -18A$
- $R_{DS(ON)} < 45m\Omega @ V_{GS} = -10V$
- $R_{DS(ON)} < 65m\Omega @ V_{GS} = -4.5V$
- High density cell design for ultra low  $R_{DS(on)}$
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high  $E_{AS}$
- Excellent package for good heat dissipation
- Special process technology for high ESD capability

### Application

- H-bridge
- Inverters



Schematic diagram



Marking and pin assignment

**100% UIS TESTED!**

**100%  $\Delta V_{ds}$  TESTED!**

### Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
HM609K	HM609K	TO-252-4L	-	-	-

### Absolute Maximum Ratings ( $T_c=25^\circ C$ unless otherwise noted)

Parameter		Symbol	N-Channel	P-Channel	Unit
Drain-Source Voltage		$V_{DS}$	40	-40	V
Gate-Source Voltage		$V_{GS}$	$\pm 20$	$\pm 20$	V
Continuous Drain Current	$T_c=25^\circ C$	$I_D$	30	-18	A
	$T_c=100^\circ C$		21	-12.6	
Pulsed Drain Current (Note 1)		$I_{DM}$	90	-54	A
Maximum Power Dissipation	$T_c=25^\circ C$	$P_D$	21		W
Operating Junction and Storage Temperature Range		$T_J, T_{STG}$	-55 To 175		°C

### Thermal Characteristic

Thermal Resistance, Junction-to-Case <sup>(Note 2)</sup>	$R_{\theta JC}$	7	°C/W
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N-Channel Electrical Characteristics ( $T_C=25^\circ\text{C}$  unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
<b>Off Characteristics</b>						
Drain-Source Breakdown Voltage	$\text{BV}_{\text{DSS}}$	$V_{\text{GS}}=0\text{V}, I_{\text{D}}=250\mu\text{A}$	40	-	-	V
Zero Gate Voltage Drain Current	$I_{\text{DSS}}$	$V_{\text{DS}}=40\text{V}, V_{\text{GS}}=0\text{V}$	-	-	1	$\mu\text{A}$
Gate-Body Leakage Current	$I_{\text{GSS}}$	$V_{\text{GS}}=\pm 20\text{V}, V_{\text{DS}}=0\text{V}$	-	-	$\pm 100$	nA
<b>On Characteristics</b> (Note 3)						
Gate Threshold Voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=250\mu\text{A}$	1.2	1.5	2.2	V
Drain-Source On-State Resistance	$R_{\text{DS}(\text{ON})}$	$V_{\text{GS}}=10\text{V}, I_{\text{D}}=7\text{A}$	-	12.9	16	$\text{m}\Omega$
		$V_{\text{GS}}=4.5\text{V}, I_{\text{D}}=6\text{A}$	-	18.9	24	$\text{m}\Omega$
Forward Transconductance	$g_{\text{FS}}$	$V_{\text{DS}}=10\text{V}, I_{\text{D}}=7\text{A}$	-	29	-	S
<b>Dynamic Characteristics</b> (Note 4)						
Input Capacitance	$C_{\text{iss}}$	$V_{\text{DS}}=15\text{V}, V_{\text{GS}}=0\text{V}, F=1.0\text{MHz}$	-	450	-	PF
Output Capacitance	$C_{\text{oss}}$		-	150	-	PF
Reverse Transfer Capacitance	$C_{\text{rss}}$		-	90	-	PF
<b>Switching Characteristics</b> (Note 4)						
Turn-on Delay Time	$t_{\text{d}(\text{on})}$	$V_{\text{DD}}=15\text{V}, R_{\text{L}}=2.5\Omega$ $V_{\text{GS}}=10\text{V}, R_{\text{G}}=3\Omega$	-	5	-	nS
Turn-on Rise Time	$t_{\text{r}}$		-	12	-	nS
Turn-Off Delay Time	$t_{\text{d}(\text{off})}$		-	19	-	nS
Turn-Off Fall Time	$t_{\text{f}}$		-	6	-	nS
Total Gate Charge	$Q_{\text{g}}$	$V_{\text{DS}}=15\text{V}, I_{\text{D}}=6\text{A}, V_{\text{GS}}=10\text{V}$	-	9.5	-	nC
Gate-Source Charge	$Q_{\text{gs}}$		-	2.0	-	nC
Gate-Drain Charge	$Q_{\text{gd}}$		-	1.9	-	nC
<b>Drain-Source Diode Characteristics</b>						
Diode Forward Voltage (Note 3)	$V_{\text{SD}}$	$V_{\text{GS}}=0\text{V}, I_{\text{S}}=30\text{A}$	-		1.2	V
Diode Forward Current (Note 2)	$I_{\text{S}}$		-	-	30	A

**Notes:**

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board,  $t \leq 10$  sec.
3. Pulse Test: Pulse Width  $\leq 300\mu\text{s}$ , Duty Cycle  $\leq 2\%$ .
4. Guaranteed by design, not subject to production
5. EAS condition:  $T_j=25^\circ\text{C}, V_{\text{DD}}=40\text{V}, V_{\text{G}}=10\text{V}, L=0.5\text{mH}, R_g=25\Omega$

### N-Channel Typical Electrical and Thermal Characteristics (Curves)

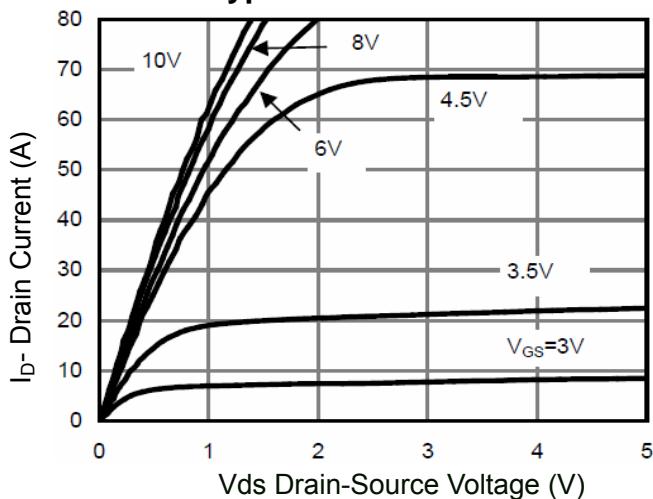


Figure 1 Output Characteristics

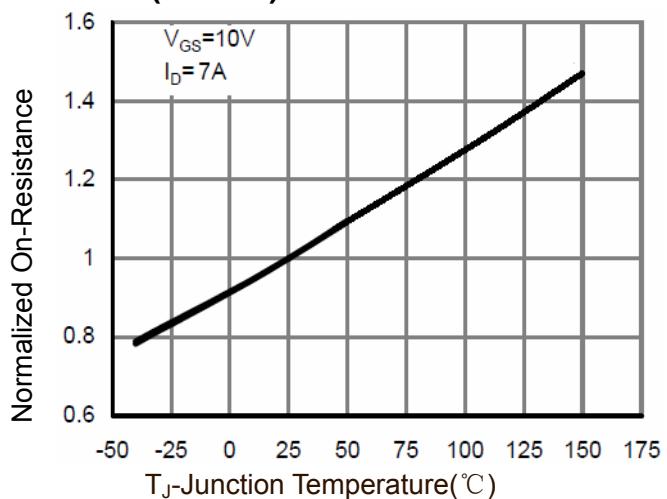


Figure 4 Rdson-Junction Temperature

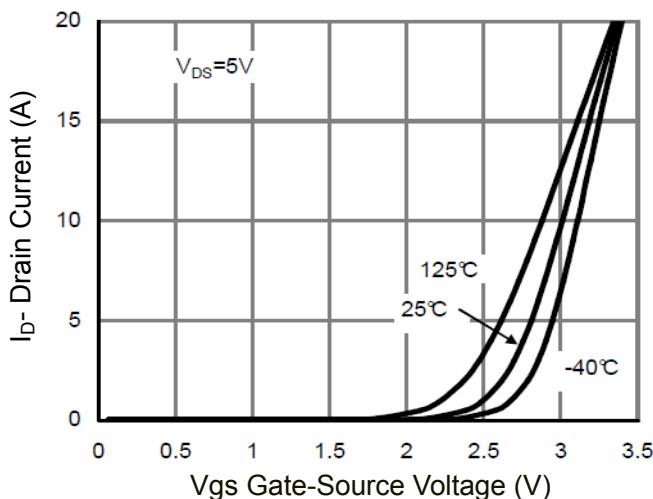


Figure 2 Transfer Characteristics

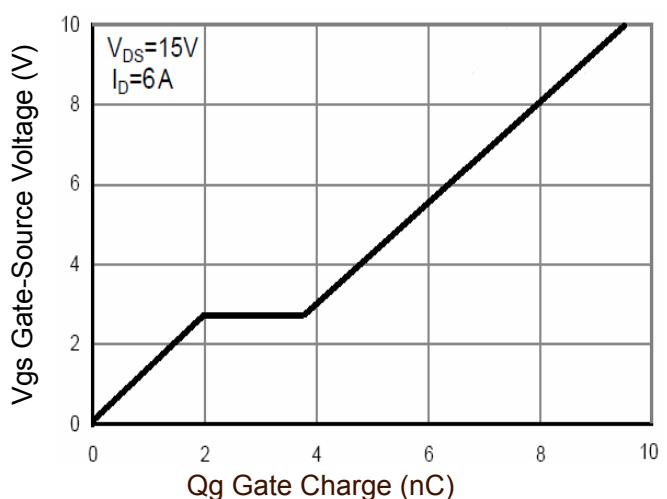


Figure 5 Gate Charge

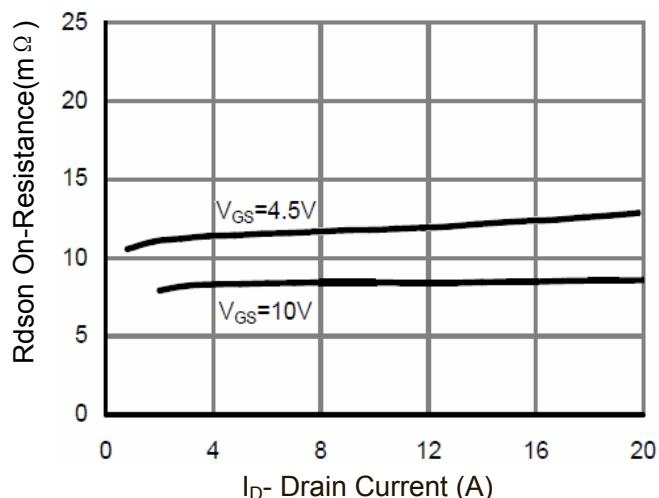


Figure 3 Rdson- Drain Current

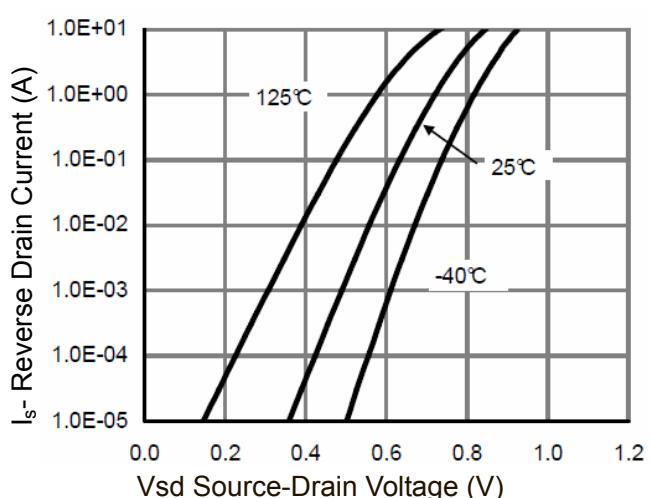


Figure 6 Source- Drain Diode Forward

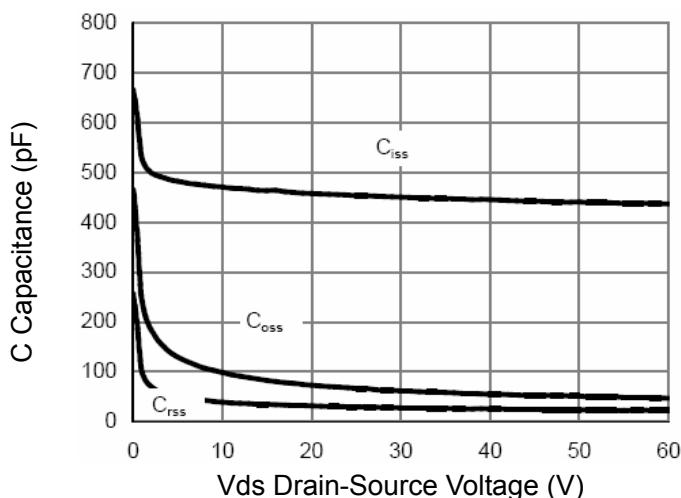


Figure 7 Capacitance vs Vds

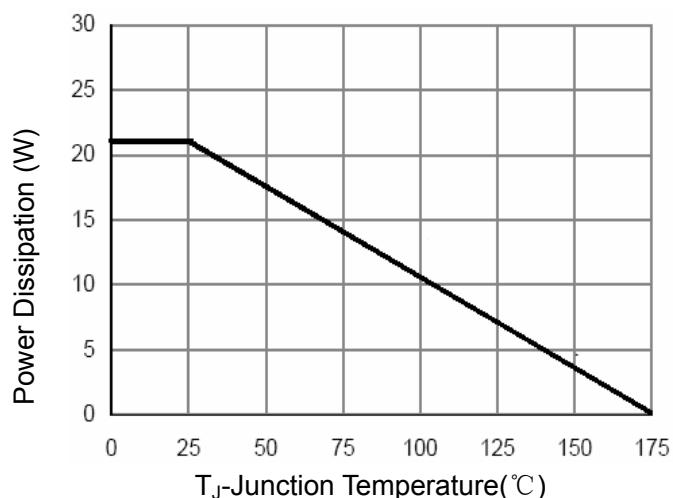


Figure 9 Figure 9 Power De-rating

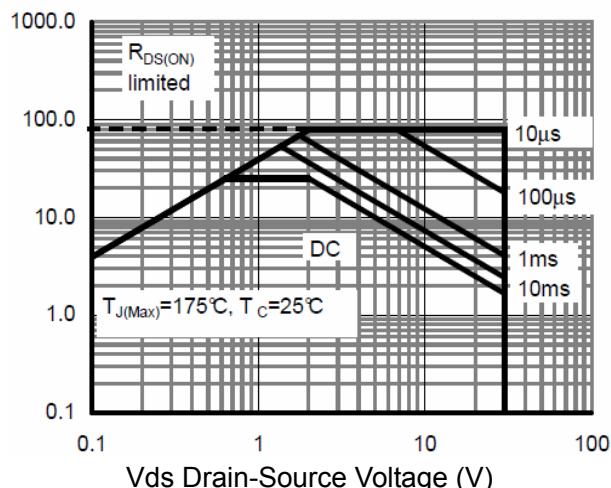


Figure 8 Safe Operation Area

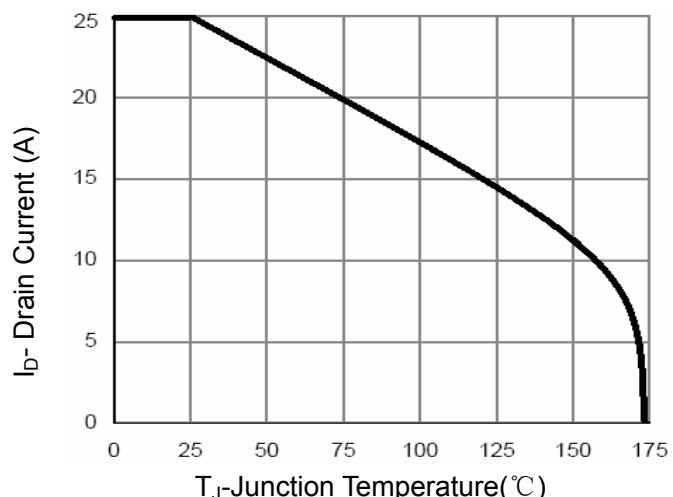
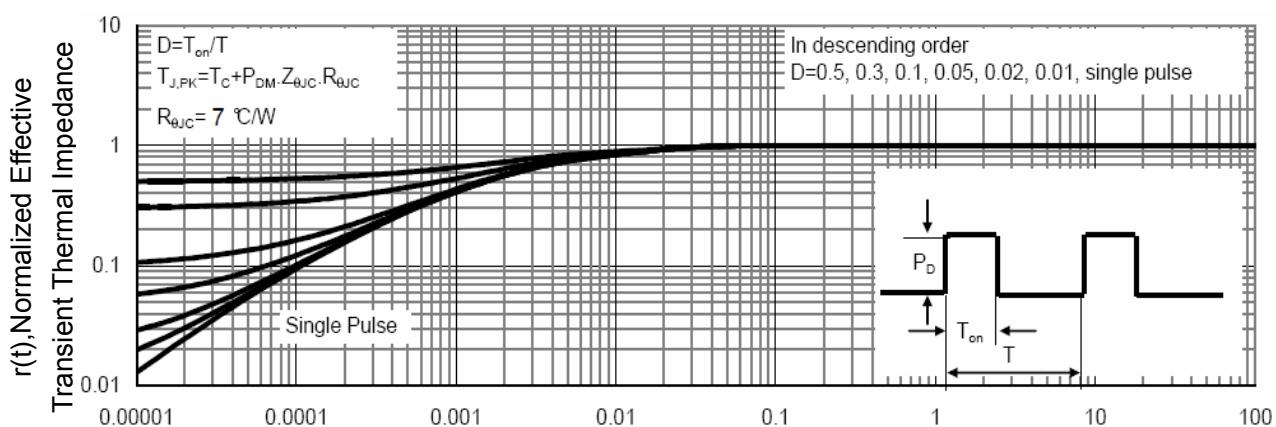


Figure 10 Current De-rating



Square Wave Pulse Duration(sec)  
 Figure 11 Normalized Maximum Transient Thermal Impedance

P-Channel Electrical Characteristics ( $T_C=25^\circ\text{C}$  unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
<b>Off Characteristics</b>						
Drain-Source Breakdown Voltage	$\text{BV}_{\text{DSS}}$	$\text{V}_{\text{GS}}=0\text{V}, \text{I}_D=-250\mu\text{A}$	-40	-	-	V
Zero Gate Voltage Drain Current	$\text{I}_{\text{DSS}}$	$\text{V}_{\text{DS}}=-40\text{V}, \text{V}_{\text{GS}}=0\text{V}$	-	-	-1	$\mu\text{A}$
Gate-Body Leakage Current	$\text{I}_{\text{GSS}}$	$\text{V}_{\text{GS}}=\pm20\text{V}, \text{V}_{\text{DS}}=0\text{V}$	-	-	$\pm100$	nA
<b>On Characteristics</b> <small>(Note 3)</small>						
Gate Threshold Voltage	$\text{V}_{\text{GS}(\text{th})}$	$\text{V}_{\text{DS}}=\text{V}_{\text{GS}}, \text{I}_D=-250\mu\text{A}$	-1.3	-	-2.5	V
Drain-Source On-State Resistance	$\text{R}_{\text{DS}(\text{ON})}$	$\text{V}_{\text{GS}}=-10\text{V}, \text{I}_D=-6\text{A}$	-	-	45	$\text{m}\Omega$
		$\text{V}_{\text{GS}}=-4.5\text{V}, \text{I}_D=-5\text{A}$		-	65	
Forward Transconductance	$\text{g}_{\text{FS}}$	$\text{V}_{\text{DS}}=-5\text{V}, \text{I}_D=-6\text{A}$	-	15	-	S
<b>Dynamic Characteristics</b> <small>(Note 4)</small>						
Input Capacitance	$\text{C}_{\text{iss}}$	$\text{V}_{\text{DS}}=-40\text{V}, \text{V}_{\text{GS}}=0\text{V},$ $F=1.0\text{MHz}$	-	920	-	PF
Output Capacitance	$\text{C}_{\text{oss}}$		-	140	-	PF
Reverse Transfer Capacitance	$\text{C}_{\text{rss}}$		-	90	-	PF
<b>Switching Characteristics</b> <small>(Note 4)</small>						
Turn-on Delay Time	$t_{\text{d}(\text{on})}$	$\text{V}_{\text{DD}}=-15\text{V}, \text{R}_L=2.5\Omega$ $\text{V}_{\text{GS}}=-10\text{V}, \text{R}_G=3\Omega$	-	8	-	nS
Turn-on Rise Time	$t_r$		-	30	-	nS
Turn-Off Delay Time	$t_{\text{d}(\text{off})}$		-	22	-	nS
Turn-Off Fall Time	$t_f$		-	26	-	nS
Total Gate Charge	$\text{Q}_g$	$\text{V}_{\text{DS}}=-15\text{V}, \text{I}_D=-6\text{A},$ $\text{V}_{\text{GS}}=-10\text{V}$	-	16.2		nC
Gate-Source Charge	$\text{Q}_{\text{gs}}$		-	2.9		nC
Gate-Drain Charge	$\text{Q}_{\text{gd}}$		-	3.6		nC
<b>Drain-Source Diode Characteristics</b>						
Diode Forward Voltage <small>(Note 3)</small>	$\text{V}_{\text{SD}}$	$\text{V}_{\text{GS}}=0\text{V}, \text{I}_S=-6\text{A}$	-		-1.2	V
Diode Forward Current <small>(Note 2)</small>	$\text{I}_S$		-	-	-18	A
Reverse Recovery Time	$t_{\text{rr}}$	$\text{TJ} = 25^\circ\text{C}, \text{IF} = -6\text{A}$ $d\text{i}/dt = 100\text{A}/\mu\text{s}$ <small>(Note 3)</small>	-	23	-	nS
Reverse Recovery Charge	$\text{Q}_{\text{rr}}$		-	14	-	nC

### P-Channel Typical Electrical and Thermal Characteristics (Curves)

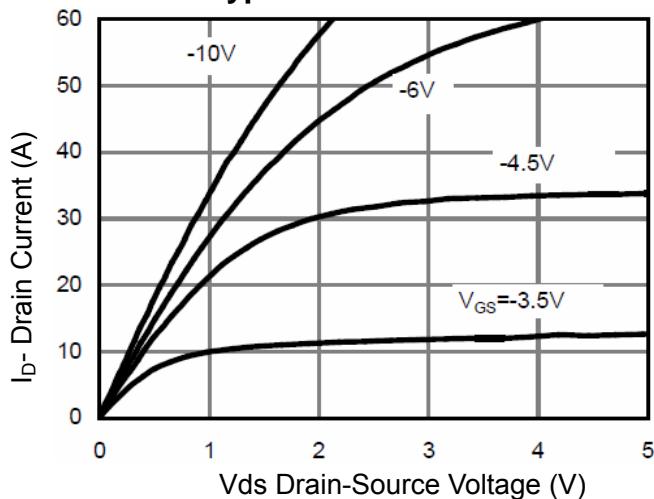


Figure 1 Output Characteristics

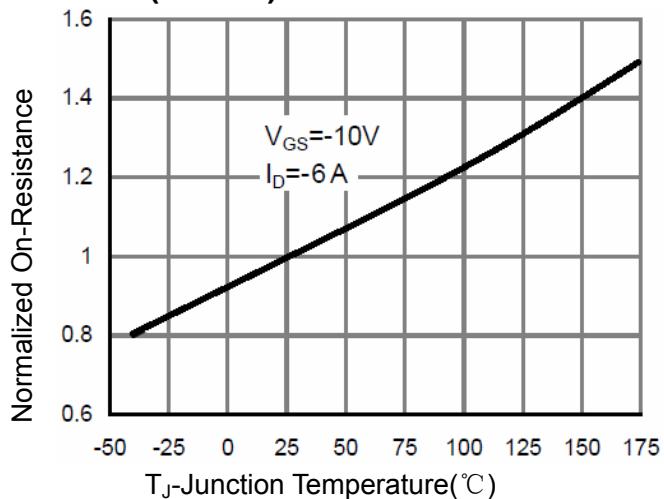


Figure 4 Rdson-Junction Temperature

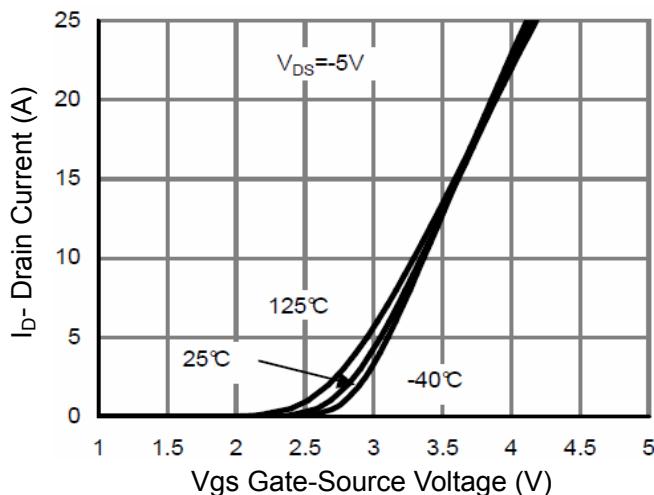


Figure 2 Transfer Characteristics

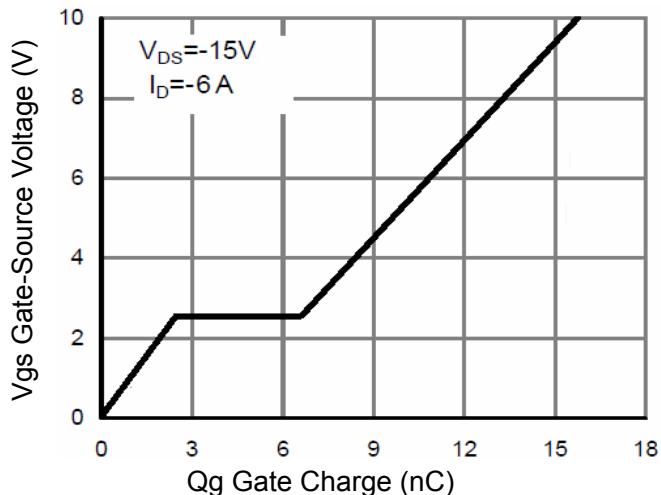


Figure 5 Gate Charge

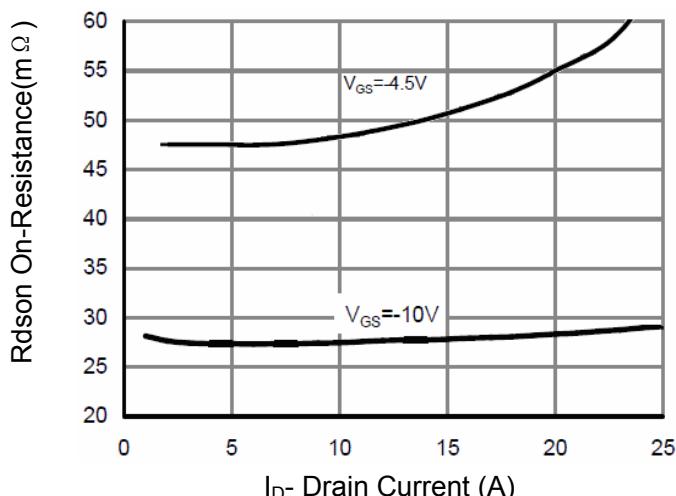


Figure 3 Rdson- Drain Current

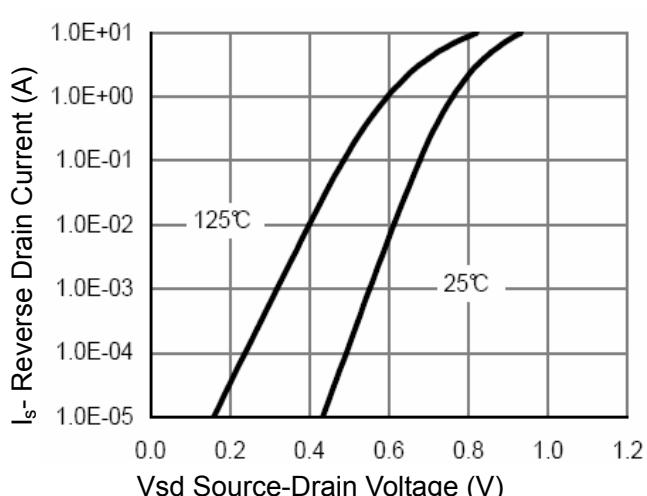


Figure 6 Source- Drain Diode Forward

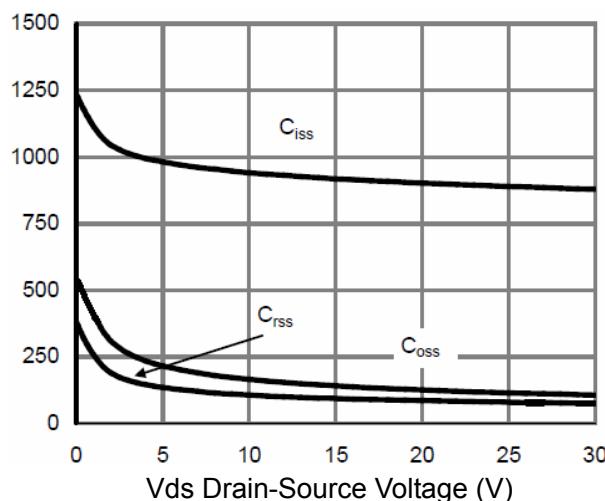


Figure 7 Capacitance vs Vds

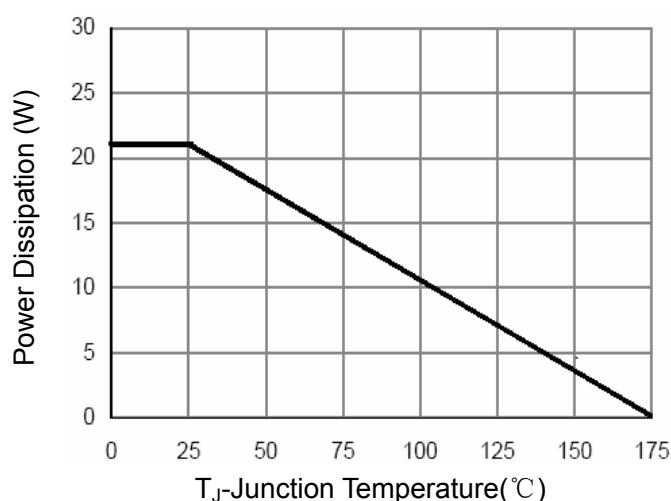


Figure 9 Power De-rating

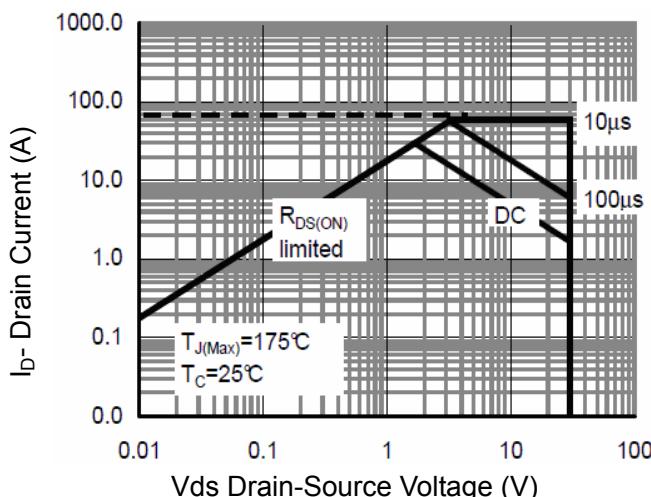


Figure 8 Safe Operation Area

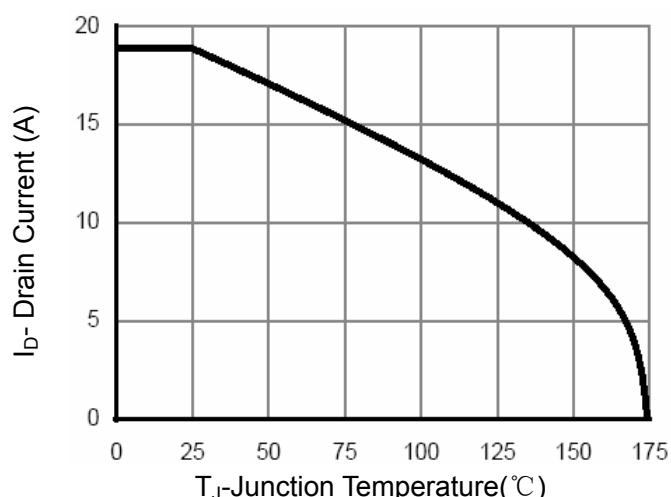


Figure 10 Current De-rating

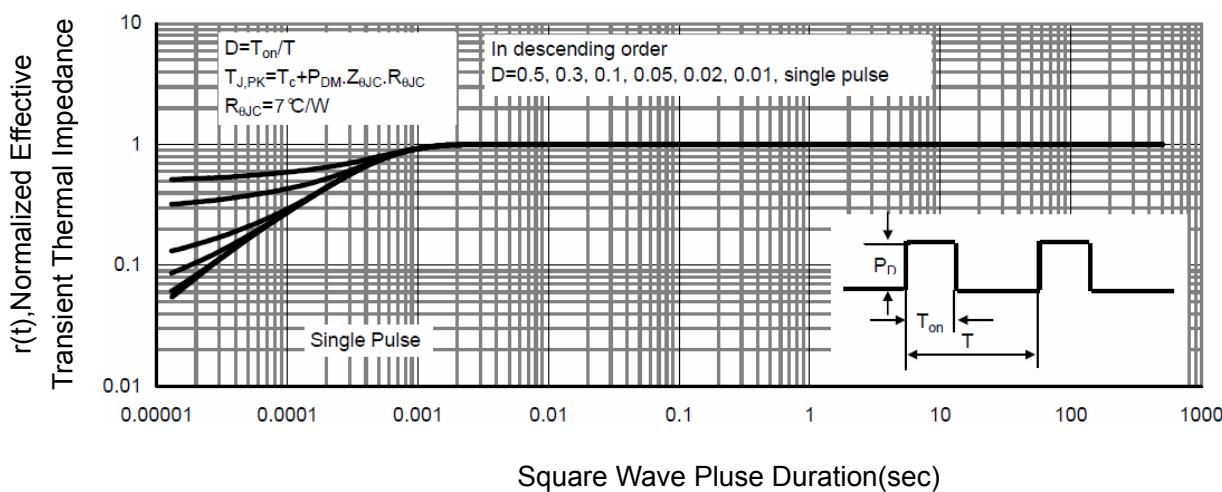
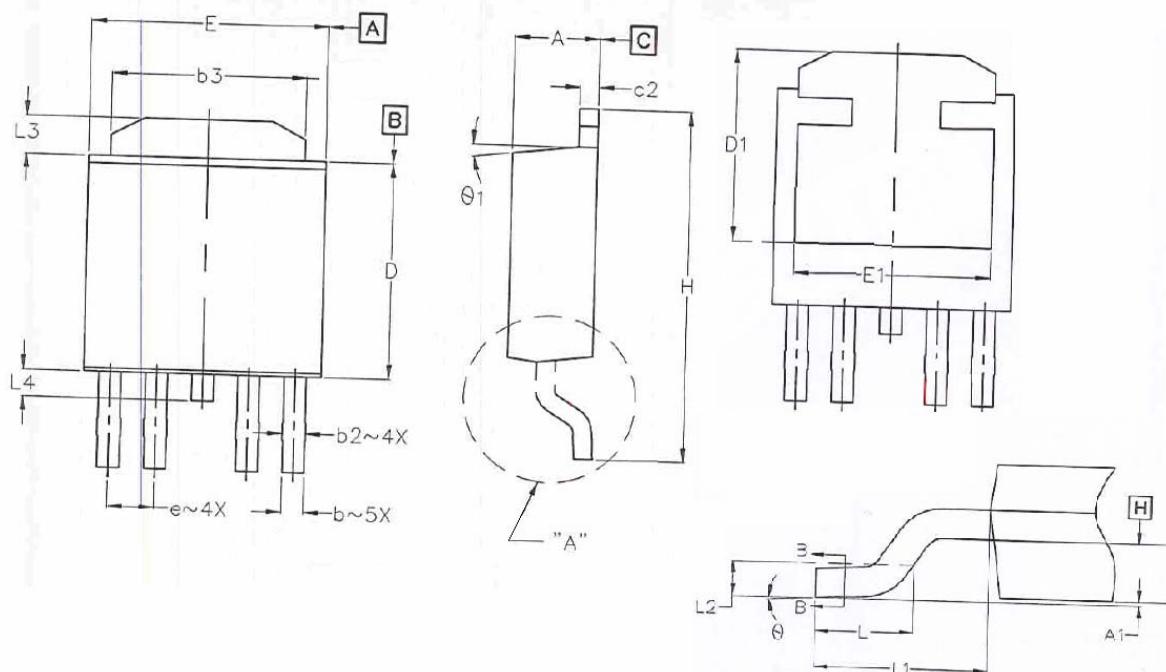


Figure 11 Normalized Maximum Transient Thermal Impedance

TO-252-4L Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	2.184	2.387	0.086	0.094
A1	-	0.127	-	0.094
b	0.508	0.711	0.020	0.028
b1	0.508	0.660	0.020	0.026
b2	0.610	0.787	0.024	0.031
b3	4.953	5.461	0.195	0.215
c	0.460	0.610	0.018	0.024
c1	0.410	0.559	0.016	0.022
C2	0.460	12.950	0.498	0.510
D	4.980	5.180	0.196	0.204
D1	2.650	2.950	0.104	0.116
E	7.900	8.100	0.311	0.319
E1	0.000	0.300	0.000	0.012
e	12.900	13.400	0.508	0.528
H	2.850	3.250	0.112	0.128
L	1.397	1.778	0.055	0.070
L1	2.743	BSC	0.108	BSC
L2	0.508	BSC	0.020	BSC
L3	0.889	1.270	0.035	0.050
L4	-	1.015	-	0.040
θ	0°	10°	0°	10°
θ1	0°	15°	0°	15°